Vishay Siliconix

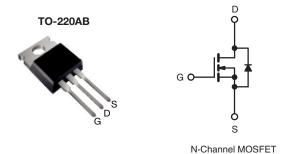
COMPLIANT

HALOGEN

FREE

D Series Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max. 550						
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.85				
Q _g (max.) (nC)	30					
Q _{gs} (nC)	4					
Q _{gd} (nC)	7					
Configuration	Single					



FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qg
 - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies
 - SMPS
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
- Battery Chargers

ORDERING INFORMATION					
Package	TO-220AB				
Lead (Pb)-free	SiHP8N50D-E3				
Lead (Pb)-free and Halogen-free	SiHP8N50D-GE3				

PARAMETER				SYMBOL	LIMIT	UNIT	
Drain-Source Voltage				V_{DS}	500		
Gate-Source Voltage				V	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)	V_{GS}	30					
Continuous Drain Current (T _J = 150 °C)		V_{GS} at 10 V $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 100 ^{\circ}\text{C}$	T _C = 25 °C	- I _D	8.7	А	
			T _C = 100 °C		5.5		
Pulsed Drain Current ^a	I _{DM}	18]				
Linear Derating Factor					1.25	W/°C	
Single Pulse Avalanche Energy ^b	E _{AS}	29	mJ				
Maximum Power Dissipation	P_{D}	156	W				
Operating Junction and Storage Temperature Range				T _J , T _{stg}	- 55 to + 150	°C	
Drain-Source Voltage Slope T _J = 125 °C			dV/dt	24	V/ns		
Reverse Diode dV/dt ^d				uv/ut	0.37	7 7/115	
Soldering Recommendations (Peak Temperature) ^c for 10 s			300	°C			

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 5 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.8			

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				_	l .		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 250 μA		0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3	-	5	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 30 V		_	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 ^{\circ}\text{C}$		-	1 10	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$		<u> </u>	0.70	0.85	Ω
Forward Transconductance ^a	9fs		= 20 V, I _D = 4 A	-	3	-	S
Dynamic	313		- 7 0	1	l		
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	527	-	
Output Capacitance	C _{oss}	╡ ,	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$	-	52	-	-
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		8	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}			-	46	-	pF
Effective Output Capacitance, Time Related ^c	$C_{o(tr)}$	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		64		
Total Gate Charge	Qg				15	30	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 4 \text{ A}, V_{DS} = 400 \text{ V}$		-	4	-	
Gate-Drain Charge	Q _{gd}			-	7	-	
Turn-On Delay Time	t _{d(on)}			-	13	26	ns
Rise Time	t _r	V_{DD}	$V_{DD} = 400 \text{ V}, I_D = 4 \text{ A}$ $R_g = 9.1 \Omega, V_{GS} = 10 \text{ V}$		16	32	
Turn-Off Delay Time	t _{d(off)}				17	34	
Fall Time	t _f			-	11	22	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.8	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8	_
Pulsed Diode Forward Current	I _{SM}			-	-	32	- A
Diode Forward Voltage	V_{SD}	T _J = 25 °C, I _S = 4 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C, } I_F = I_S = 4 \text{ A,}$ $dI/dt = 100 \text{ A/}\mu\text{s, } V_R = 20 \text{ V}$		-	308	-	ns
Reverse Recovery Charge	Q_{rr}			-	1.8	-	μC
Reverse Recovery Current	I _{RRM}			_	11	-	Α

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

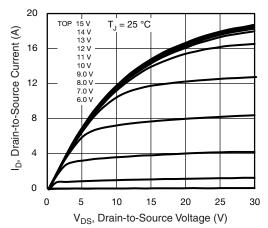


Fig. 1 - Typical Output Characteristics

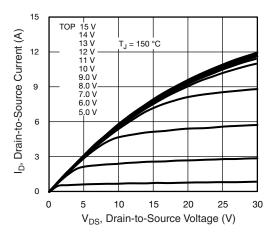


Fig. 2 - Typical Output Characteristics

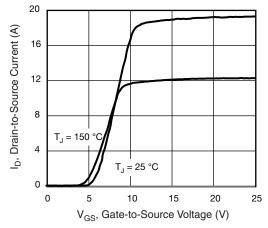


Fig. 3 - Typical Transfer Characteristics

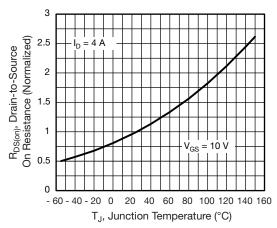


Fig. 4 - Normalized On-Resistance vs. Temperature

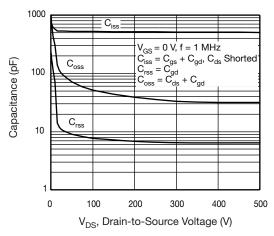


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

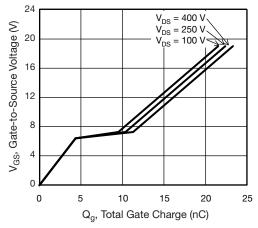


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



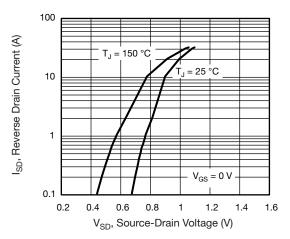


Fig. 7 - Typical Source-Drain Diode Forward Voltage

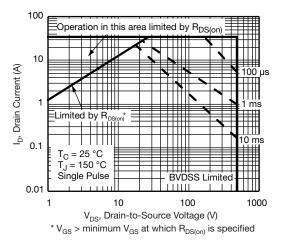


Fig. 8 - Maximum Safe Operating Area

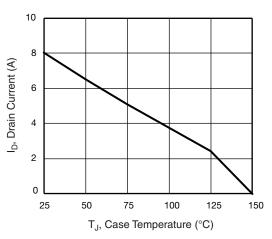


Fig. 9 - Maximum Drain Current vs. Case Temperature

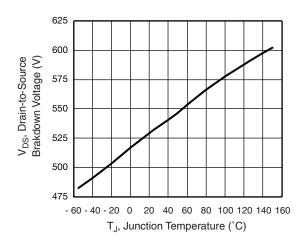


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

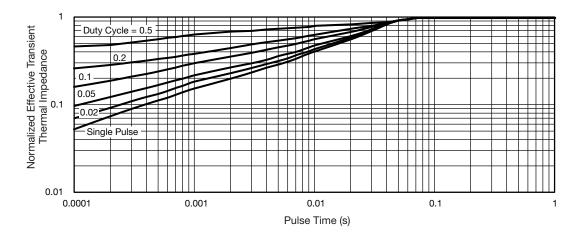


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



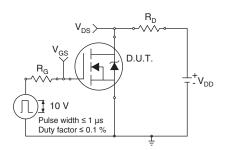


Fig. 12 - Switching Time Test Circuit

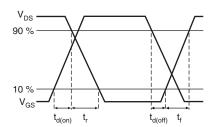


Fig. 13 - Switching Time Waveforms

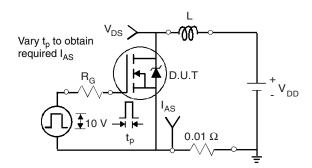


Fig. 14 - Unclamped Inductive Test Circuit

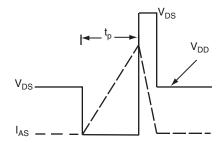


Fig. 15 - Unclamped Inductive Waveforms

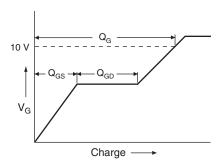


Fig. 16 - Basic Gate Charge Waveform

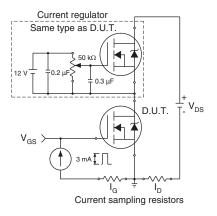
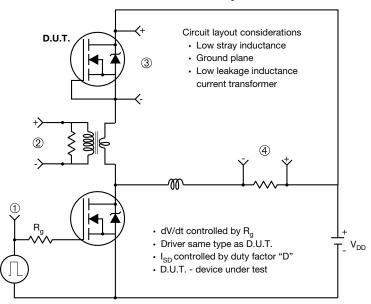


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



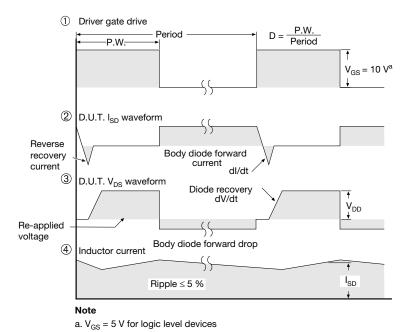
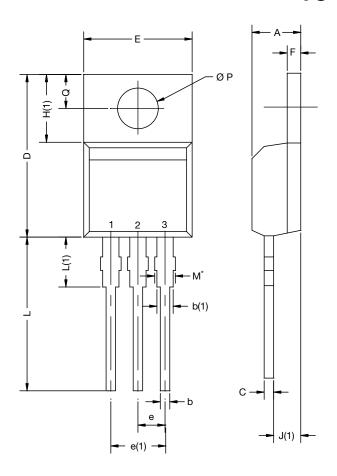


Fig. 18 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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